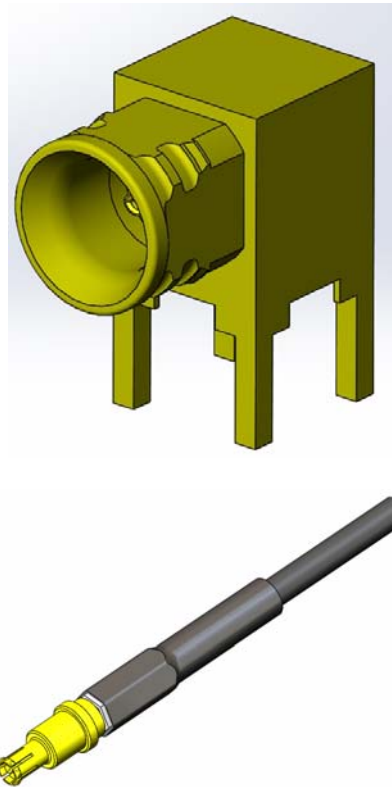




Project Number: Design Qualification Test Report	Tracking Code: 1364204_Report_Rev_1
Requested by: Alvin Wang	Date: 2/28/2018
Part #: MMCX7-J-P-GF-RA-TH1/RF179-73SP4-73SP4-0406	
Part description: MMCX7/RF179	Tech: Tony Wagoner
Test Start: 1/24/2018	Test Completed: 1/25/2018



**DESIGN QUALIFICATION TEST REPORT**  
**MMCX7/RF179**  
**MMCX7-J-P-GF-RA-TH1/RF179-73SP4-73SP4-0406**

Tracking Code: 1364204_Report_Rev_1	Part #: MMCX7-J-P-GF-RA-TH1/RF179-73SP4-73SP4-0406
Part description: MMCX7-RF179	

**REVISION HISTORY**

<b>DATA</b>	<b>REV.NUM.</b>	<b>DESCRIPTION</b>	<b>ENG</b>
2/28/2018	1	Initial Issue	KH

## **CERTIFICATION**

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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## **SCOPE**

To perform the following tests: Design Qualification test. Please see test plan.

## **APPLICABLE DOCUMENTS**

Standards: EIA Publication 364

## **TEST SAMPLES AND PREPARATION**

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free
- 9) Samtec Test PCBs used: PCB-103846-TST

## FLOWCHARTS

### Mechanical Shock/Random Vibration/Event Detection

#### Group 1

MMCX7-J-P-GF-RA-TH1  
RF179-73SP4-73SP4-0406  
60 Points

Step	Description
1.	Nanosecond Event Detection (Mechanical Shock) <sup>(1)</sup>
2.	Nanosecond Event Detection (Random Vibration) <sup>(2)</sup>

#### (1) Nanosecond Event Detection (Mechanical Shock)

Use EIA-364-87 for Nanosecond Event Detection:  
Test Condition = F (50 nanoseconds at 10 ohms)  
Use EIA-364-27 for Mechanical Shock:  
Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)  
Number of Shocks = 3 Per Direction, Per Axis, 18 Total

#### (2) Nanosecond Event Detection (Random Vibration)

Use EIA-364-87 for Nanosecond Event Detection:  
Test Condition = F (50 nanoseconds at 10 ohms)  
Use EIA-364-28 for Random Vibration:  
Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

### Mechanical Shock/Random Vibration/LLCR

#### Group 1

MMCX7-J-P-GF-RA-TH1  
RF179-73SP4-73SP4-0406  
8 Assemblies

Step	Description
1.	LLCR <sup>(1)</sup>
2.	Mechanical Shock <sup>(2)</sup>
3.	Random Vibration <sup>(3)</sup>
4.	LLCR <sup>(1)</sup> Max Delta = 15 mOhm

#### (1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max  
Test Current = 100 mA Max

#### (2) Mechanical Shock = EIA-364-27

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)  
Number of Shocks = 3 Per Direction, Per Axis, 18 Total

#### (3) Random Vibration = EIA-364-28

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

**ATTRIBUTE DEFINITIONS**

The following is a brief, simplified description of attributes.

**MECHANICAL SHOCK (Specified Pulse):**

- 1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
- 2) Test Condition A
- 3) Peak Value: 50 G
- 4) Duration: 11 Milliseconds
- 5) Wave Form: Half Sine
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

**VIBRATION:**

- 1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
- 2) Test Condition VII, Letter D
- 3) Power Spectral Density: 0.04 G<sup>2</sup> / Hz
- 4) G 'RMS': 3.10
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 15 Minutes per axis (45 Minutes total)

**NANOSECOND-EVENT DETECTION:**

- 1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

**LLCR:**

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
  - a. <= +5.0 mOhms: ----- Stable
  - b. +5.1 to +8.0 mOhms: ----- Minor
  - c. +8.1 to +10.0 mOhms: ----- Acceptable
  - d. +10.1 to +50.0 mOhms: ----- Marginal
  - e. +50.1 to +2000 mOhms: ----- Unstable
  - f. >+2000 mOhms: ----- Open Failure

**RESULTS****LLCR Shock & Vibration Group (8 signal and 8 ground LLCR test points)****Signal pin**

- Initial ----- 266.96 mOhms Max
- Shock & Vibration
  - ≤ +5.0 mOhms ----- 8 Points ----- Stable
  - +5.1 to +8.0 mOhms ----- 0 Points ----- Minor
  - +8.1 to +10.0 mOhms ----- 0 Points ----- Acceptable
  - +10.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**Ground pin**

- Initial ----- 11.44 mOhms Max
- Shock & Vibration
  - ≤ +5.0 mOhms ----- 8 Points ----- Stable
  - +5.1 to +8.0 mOhms ----- 0 Points ----- Minor
  - +8.1 to +10.0 mOhms ----- 0 Points ----- Acceptable
  - +10.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**Mechanical Shock & Random Vibration:**

- Shock
  - No Damage ----- Pass
  - 50 Nanoseconds ----- Pass
- Vibration
  - No Damage ----- Pass
  - 50 Nanoseconds ----- Pass

**DATA SUMMARIES****LLCR Shock & Vibration Group:**

- 1). A total of 8 signal and 8 ground points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
  - a.  $\leq +5.0$  mOhms: ----- Stable
  - b.  $+5.1$  to  $+8.0$  mOhms:----- Minor
  - c.  $+8.1$  to  $+10.0$  mOhms:----- Acceptable
  - d.  $+10.1$  to  $+50.0$  mOhms:----- Marginal
  - e.  $+50.1$  to  $+2000$  mOhms ----- Unstable
  - f.  $>+2000$  mOhms:----- Open Failure

<b>LLCR Measurement Summaries by Pin Type</b>				
Date	1/24/2018	1/25/2018		
Room Temp (Deg C)	23	22		
Rel Humidity (%)	32	32		
Technician	Tony Wagoner	Tony Wagoner		
mOhm values	<b>Actual Initial</b>	<b>Delta Shock-Vib</b>	<b>Delta</b>	<b>Delta</b>
<b>Pin Type 1: Ground</b>				
Average	11.23	0.16		
St. Dev.	0.18	0.08		
Min	10.93	0.00		
Max	11.44	0.31		
Summary Count	8	8		
Total Count	8	8		
<b>Pin Type 2: Signal</b>				
Average	264.27	0.89		
St. Dev.	1.10	0.61		
Min	263.40	0.21		
Max	266.96	1.72		
Summary Count	8	8		
Total Count	8	8		

<b>LLCR Delta Count by Category</b>						
	<b>Stable</b>	<b>Minor</b>	<b>Acceptable</b>	<b>Marginal</b>	<b>Unstable</b>	<b>Open</b>
mOhms	$\leq 5$	$>5 \text{ \& } \leq 10$	$>10 \text{ \& } \leq 15$	$>15 \text{ \& } \leq 50$	$>50 \text{ \& } \leq 1000$	$>1000$
<b>Shock-Vib</b>	<b>16</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>

**Nanosecond Event Detection:**

<b>Shock and Vibration Event Detection Summary</b>	
Contacts tested	16
Test Condition	C, 100g's, 6ms, Half-Sine
Shock Events	0
Test Condition	V-B, 7.56 rms g
Vibration Events	0
<b>Total Events</b>	<b>0</b>

**EQUIPMENT AND CALIBRATION SCHEDULES****Equipment #:** MO-11**Description:** Switch/Multimeter**Manufacturer:** Keithley**Model:** 3706**Serial #:** 120169**Accuracy:** See Manual

... Last Cal: 09/11/2017, Next Cal: 09/11/2018

**Equipment #:** SVC-01**Description:** Shock & Vibration Table**Manufacturer:** Data Physics**Model:** LE-DSA-10-20K**Serial #:** 10037**Accuracy:** See Manual

... Last Cal: 04/22/2017, Next Cal: 04/22/2018

**Equipment #:** ACLM-01**Description:** Accelerometer**Manufacturer:** PCB Piezotronics**Model:** 352C03**Serial #:** 115819**Accuracy:** See Manual

... Last Cal: 07/18/2017, Next Cal: 07/18/2018

**Equipment #:** ED-03**Description:** Event Detector**Manufacturer:** Analysis Tech**Model:** 32EHD**Serial #:** 1100604**Accuracy:** See Manual

... Last Cal: 10/31/2017, Next Cal: 10/31/2018